

Title (en)

Stencil printed method and heat-sensitive stencil sheet

Title (de)

Schablonendruckverfahren und wärmeempfindliches Schablonenblatt

Title (fr)

Procédé pour imprimer au pochoir et feuille stencil sensible à la chaleur

Publication

EP 0688681 B1 19970903 (EN)

Application

EP 95303415 A 19950522

Priority

JP 10869694 A 19940523

Abstract (en)

[origin: EP0688681A1] A stencil printing method in which printing ink is smoothly supplied to perforations formed in a thermoplastic resin film of a stencil sheet, thereby providing clear print images. Also disclosed is a heat-sensitive stencil sheet which is used in such a method. The method comprises forming a perforated image made up of a multiplicity of independent discontinuous perforations in the thermoplastic resin film by a perforated image-forming device, supplying a printing ink capable of dissolving said adhesive from the side of the ink-permeable sheet, so as to dissolve said adhesive and pass through the perforated image of the resin film, thereby effecting stencil printing on the printing medium. The heat-sensitive stencil sheet of the invention has a structure in which an adhesive contained therein is dissolved by the printing ink supplied to the stencil sheet during printing. <IMAGE>

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